February 1999

FDC6306P

Dual P-Channel 2.5V Specified PowerTrenchTM MOSFET

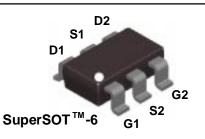
General Description

These P-Channel 2.5V specified MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the bigger more expensive SO-8 and TSSOP-8 packages are impractical.

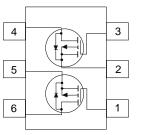
Applications

- Load switch
- Battery protection
- Power management



Features

- -1.9 A, -20 V. $R_{DS(on)} = 0.170 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(on)} = 0.250\Omega \ @ V_{GS} = -2.5 \ V$
- Low gate charge (3 nC typical).
- Fast switching speed.
- High performance trench technology for extremely low $\rm R_{\rm DS(ON)}.$
- SuperSOTTM-6 package: small footprint (72% smaller than standard SO-8); low profile (1mm thick).



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		<u>+</u> 8	V
D	Drain Current - Continuous - Pulsed	(Note 1a)	-1.9 -5	A
P _D	Power Dissipation for Single Operation	(Note 1a)	0.96	W
		(Note 1b)	0.9	
		(Note 1c)	0.7	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	۰C

Thermal Characteristics

$R_{\theta^{JA}}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	∘C/W
R _θ JC	Thermal Resistance, Junction-to-Case	(Note 1)	60	∘C/W

Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
.306	FDC6306P	7"	8mm	3000 units

-20 25°C -0.4 25°C 25°C -5 -5	-18 -0.9 3 0.127 0.182 0.194 4	-1 100 -100 -1.5 0.170 0.270 0.250	V mV/°C μA nA NA NA Ω A
25°C -0.4 25°C 25°C 25°C	-0.9 3 0.127 0.182 0.194	100 -100 -1.5 0.170 0.270	mV/°C μA nA nA V mV/°C Ω
-0.4 25°C 25°C	-0.9 3 0.127 0.182 0.194	100 -100 -1.5 0.170 0.270	μA nA nA W mV/°C
25°C 25°C	3 0.127 0.182 0.194	100 -100 -1.5 0.170 0.270	nA nA V mV/°C Ω
25°C 25°C	3 0.127 0.182 0.194	-100 -1.5 0.170 0.270	nA V mV/∘C Ω
25°C 25°C	3 0.127 0.182 0.194	-1.5 0.170 0.270	V mV/∘C Ω
25°C 25°C	3 0.127 0.182 0.194	0.170 0.270	mV/∘C
25°C 25°C	3 0.127 0.182 0.194	0.170 0.270	mV/∘C
25°C	0.127 0.182 0.194	0.270	Ω
	0.182 0.194	0.270	
-5	4		А
	4		
			S
Ι		·	-
	441		pF
	127		pF
	67		pF
		<u>.</u>	
	6	12	ns
	9	18	ns
	14	25	ns
	3	9	ns
	3	4.2	nC
	0.7		nC
	0.8		nC
		-0.8	А
2)	-0.8	-	V
r	ence is defined a	9 14 3 0.7 0.8 2) -0.8 ence is defined as the solde	9 18 14 25 3 9 3 4.2 0.7 0.8



Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width $\leq 300~\mu s,$ Duty Cycle $\leq 2.0\%$

mounted on a 0.125 in² pad of 2 oz. copper.

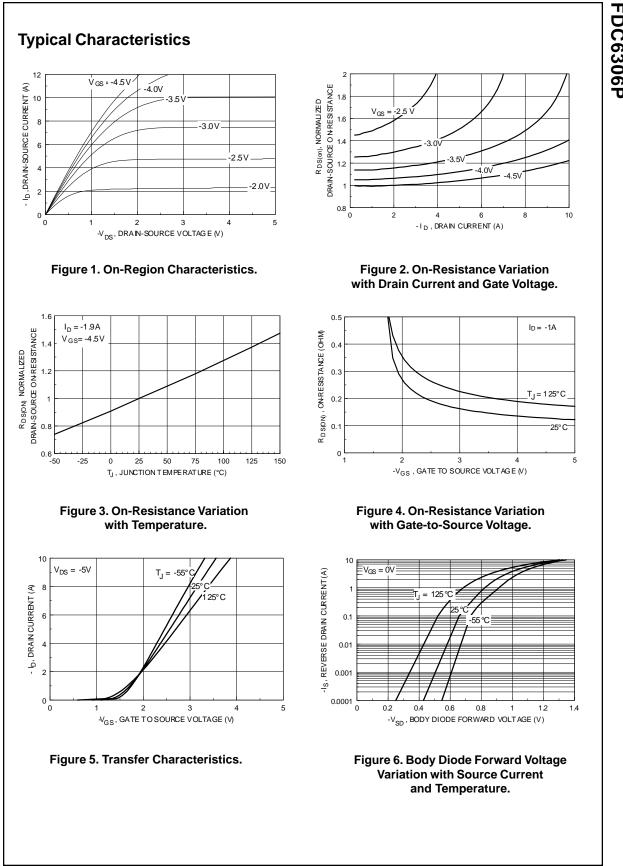


mounted on a 0.005 in² pad of 2 oz. copper.

mounted on a 0.0015 in² pad of 2 oz. copper.

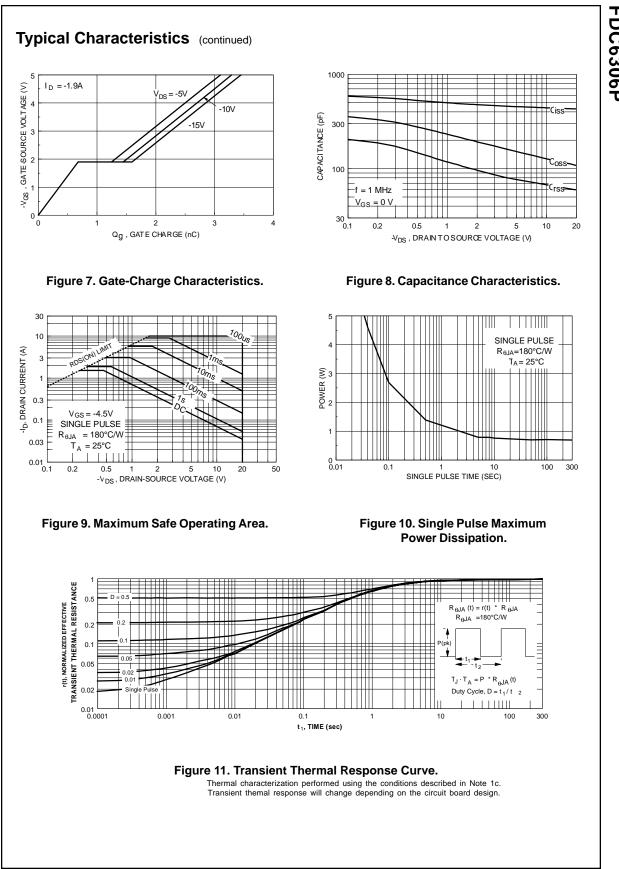
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